

## Fast Recovery Diode

### Type M1102NC500 to M1102NC600

Old Type No.: SM46-56CXC574

#### Absolute Maximum Ratings

	VOLTAGE RATINGS	MAXIMUM LIMITS	UNITS
$V_{RRM}$	Repetitive peak reverse voltage, (note 1)	5000-6000	V
$V_{RSM}$	Non-repetitive peak reverse voltage, (note 1)	5100-6100	V

	OTHER RATINGS	MAXIMUM LIMITS	UNITS
$I_{F(AVM)}$	Maximum average forward current, $T_{sink}=55^{\circ}C$ , (note 2)	1102	A
$I_{F(AVM)}$	Maximum average forward current. $T_{sink}=85^{\circ}C$ , (note 2)	756	A
$I_{F(AVM)}$	Maximum average forward. $T_{sink}=85^{\circ}C$ , (note 3)	457	A
$I_{F(RMS)}$	Nominal RMS forward current, $T_{sink}=25^{\circ}C$ , (note 2)	2182	A
$I_{f(d.c.)}$	D.C. forward current, $T_{sink}=25^{\circ}C$ , (note 4)	1886	A
$I_{FSM}$	Peak non-repetitive surge $t_p=10ms$ , $V_{RM}=0.6V_{RRM}$ , (note 5)	13	kA
$I_{FSM2}$	Peak non-repetitive surge $t_p=10ms$ , $V_{RM}\leq 10V$ , (note 5)	14.3	kA
$I^2t$	$I^2t$ capacity for fusing $t_p=10ms$ , $V_{RM}=0.6V_{RRM}$ , (note 5)	$845\times 10^3$	$A^2s$
$I^2t$	$I^2t$ capacity for fusing $t_p=10ms$ , $V_{RM}\leq 10V$ , (note 5)	$1.02\times 10^6$	$A^2s$
$T_s$	Operating temperature range	-40 to +125	$^{\circ}C$
$T_{stg}$	Storage temperature range	-40 to +150	$^{\circ}C$

#### Notes:-

- 1) De-rating factor of 0.13% per  $^{\circ}C$  is applicable for  $T_j$  below  $25^{\circ}C$ .
- 2) Double side cooled, single phase; 50Hz,  $180^{\circ}$  half-sinewave.
- 3) Single side cooled, single phase; 50Hz,  $180^{\circ}$  half-sinewave.
- 4) Double side cooled.
- 5) Half-sinewave,  $125^{\circ}C$   $T_j$  initial.

### Characteristics

	PARAMETER	MIN.	TYP.	MAX.	TEST CONDITIONS (Note 1)	UNITS
$V_{FM}$	Maximum peak forward voltage	-	-	2.2	$I_{FM}=1500A$	V
$V_{FM}$	Maximum peak forward voltage	-	-	2.57	$I_{FM}=2200A$	V
$V_{T0}$	Threshold voltage	-	-	1.36		V
$r_T$	Slope resistance	-	-	0.557		mΩ
$V_{FRM}$	Maximum forward recovery voltage	-	-	450	$di/dt = 1000A/\mu s$	V
		-	-	270	$di/dt = 1000A/\mu s, T_j = 25^\circ C$	V
$I_{RRM}$	Peak reverse current	-	-	60	Rated $V_{RRM}$	mA
$Q_{rr}$	Recovered charge	-	3300	-	$I_{FM}=1000A, t_0=500\mu s, di/dt=200A/\mu s, V_r=50V, 50\% \text{ Chord.}$	μC
$Q_{ra}$	Recovered charge, 50% Chord	-	1500	2000		μC
$I_{rm}$	Reverse recovery current	-	550	-		A
$t_{rr}$	Reverse recovery time, 50% Chord	-	5.5	-		μs
$R_{thJK}$	Thermal resistance, junction to heatsink	-	-	0.022	Double side cooled	K/W
		-	-	0.044	Single side cooled	
F	Mounting force	19	-	26		kN
$W_t$	Weight	-	480	-		g

Notes:-

1) Unless otherwise indicated  $T_j=125^\circ C$ .

## Notes on Ratings and Characteristics

### 1.0 Voltage Grade Table

Voltage Grade	$V_{RRM}$ (V)	$V_{RSM}$ (V)	$V_R$ dc (V)
50	5000	5100	2200
52	5200	5300	2240
54	5400	5500	2280
56	5600	5700	2320
58	5800	5900	2360
60	6000	6100	2400

### 2.0 De-rating Factor

A blocking voltage de-rating factor of 0.13% per °C is applicable to this device for  $T_j$  below 25°C.

### 3.0 ABCD Constants

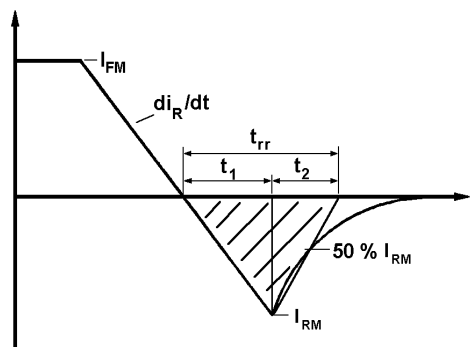
These constants (applicable only over current range of  $V_F$  characteristic in Figure 1) are the coefficients of the expression for the forward characteristic given below:

$$V_F = A + B \cdot \ln(I_F) + C \cdot I_F + D \cdot \sqrt{I_F}$$

where  $I_F$  = instantaneous forward current.

### 4.0 Reverse recovery ratings

(i)  $Q_{ra}$  is based on 50%  $I_{rm}$  chord as shown in Fig.(a) below.



(ii)  $Q_{rr}$  is based on a 150μs integration time.

i.e.

$$Q_{rr} = \int_0^{150\mu s} i_{rr} \cdot dt$$

(iii)

$$K \text{ Factor} = \frac{t_1}{t_2}$$

### 5.0 Reverse Recovery Loss

The following procedure is recommended for use where it is necessary to include reverse recovery loss.

From waveforms of recovery current obtained from a high frequency shunt (see Note 1) and reverse voltage present during recovery, an instantaneous reverse recovery loss waveform must be constructed. Let the area under this waveform be  $E$  joules per pulse. A new sink temperature can then be evaluated from:

$$T_{SINK} = T_{J(MAX)} - E \cdot [k + f \cdot R_{th(J-Hs)}]$$

Where  $k = 0.2314$  ( $^{\circ}\text{C/W}$ )/s

$E$  = Area under reverse loss waveform per pulse in joules (W.s.)

$f$  = Rated frequency in Hz at the original sink temperature.

$R_{th(J-Hs)}$  = d.c. thermal resistance ( $^{\circ}\text{C/W}$ )

The total dissipation is now given by:

$$W_{(tot)} = W_{(original)} + E \cdot f$$

#### NOTE 1 - Reverse Recovery Loss by Measurement

This device has a low reverse recovered charge and peak reverse recovery current. When measuring the charge, care must be taken to ensure that:

(a) AC coupled devices such as current transformers are not affected by prior passage of high amplitude forward current.

(b) A suitable, polarised, clipping circuit must be connected to the input of the measuring oscilloscope to avoid overloading the internal amplifiers by the relatively high amplitude forward current signal.

(c) Measurement of reverse recovery waveform should be carried out with an appropriate critically damped snubber, connected across diode anode to cathode. The formula used for the calculation of this snubber is shown below:

$$R^2 = 4 \cdot \frac{V_r}{C_s \cdot di/dt}$$

Where:  $V_r$  = Commutating source voltage

$C_s$  = Snubber capacitance

$R$  = Snubber resistance

### 6.0 Snubber Components

When selecting snubber components, care must be taken not to use excessively large values of snubber capacitor or excessively small values of snubber resistor. Such excessive component values may lead to device damage due to the large resultant values of snubber discharge current. If required, please consult the factory for assistance.

## 7.0 Computer Modelling Parameters

### 7.1 Device Dissipation Calculations

$$I_{AV} = \frac{-V_o + \sqrt{V_o^2 + 4 \cdot ff \cdot r_s \cdot W_{AV}}}{2 \cdot ff \cdot r_s}$$

Where  $V_o = 1.36V$ ,  $r_s = 0.557m\Omega$

$ff$  = form factor (normally unity for fast diode applications)

$$W_{AV} = \frac{\Delta T}{R_{th}}$$

$$\Delta T = T_{j(MAX)} - T_{Hs}$$

### 7.2 Calculation of $V_F$ using ABCD Coefficients

The forward characteristic  $I_F$  Vs  $V_F$ , on page 6 is represented in two ways;

- (i) the well established  $V_o$  and  $r_s$  tangent used for rating purposes and
- (ii) a set of constants A, B, C, and D forming the coefficients of the representative equation for  $V_F$  in terms of  $I_F$  given below:

$$V_F = A + B \cdot \ln(I_F) + C \cdot I_F + D \cdot \sqrt{I_F}$$

The constants, derived by curve fitting software, are given in this report for hot characteristics. The resulting values for  $V_F$  agree with the true device characteristic over a current range, which is limited to that plotted.

125°C Coefficients	
A	1.046854851
B	$-7.60529517 \times 10^{-4}$
C	$3.43523685 \times 10^{-4}$
D	0.0163647192

## 8.0 Frequency Ratings

The curves illustrated in figures 8 to 16 are for guidance only and are superseded by the maximum ratings shown on page 1.

### 9.0 Square wave ratings

These ratings are given for load component rate of rise of forward current of 100 and 500 A/μs.

### 10.0 Duty cycle lines

The 100% duty cycle is represented on all the ratings by a straight line. Other duties can be included as parallel to the first.

## Curves

Figure 1 – Forward characteristics of Limit device

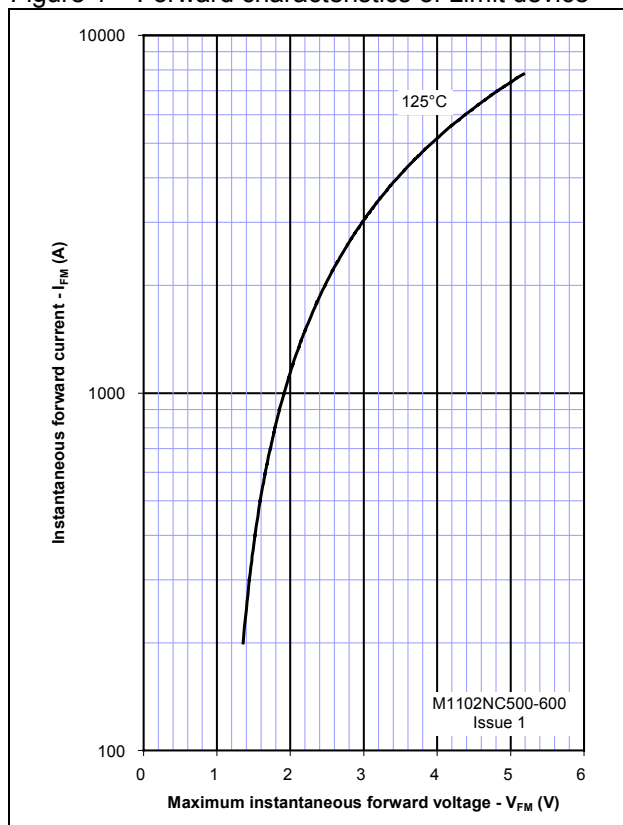


Figure 2 – Maximum forward recovery voltage

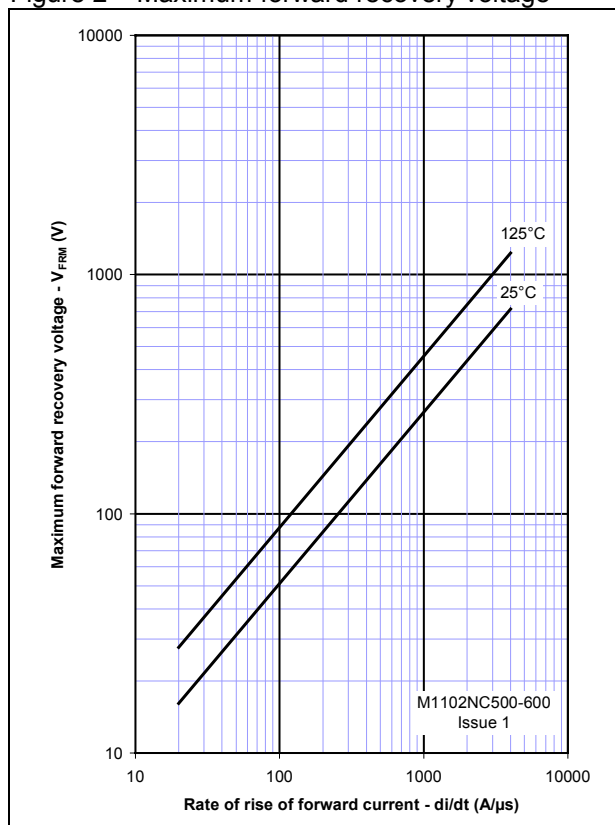


Figure 3 - Recovered charge,  $Q_{rr}$

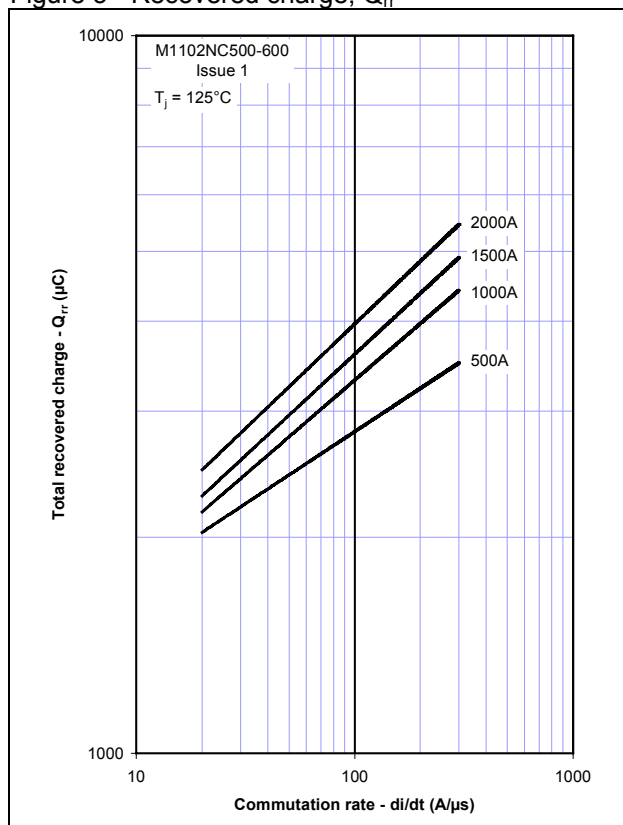


Figure 4 - Recovered charge,  $Q_{ra}$  (50% chord)

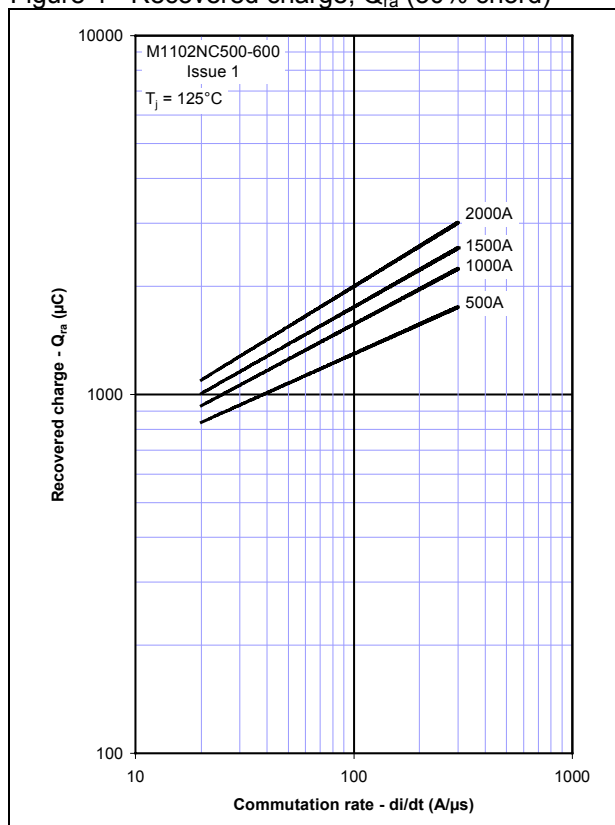


Figure 5 - Maximum reverse current,  $I_{rm}$

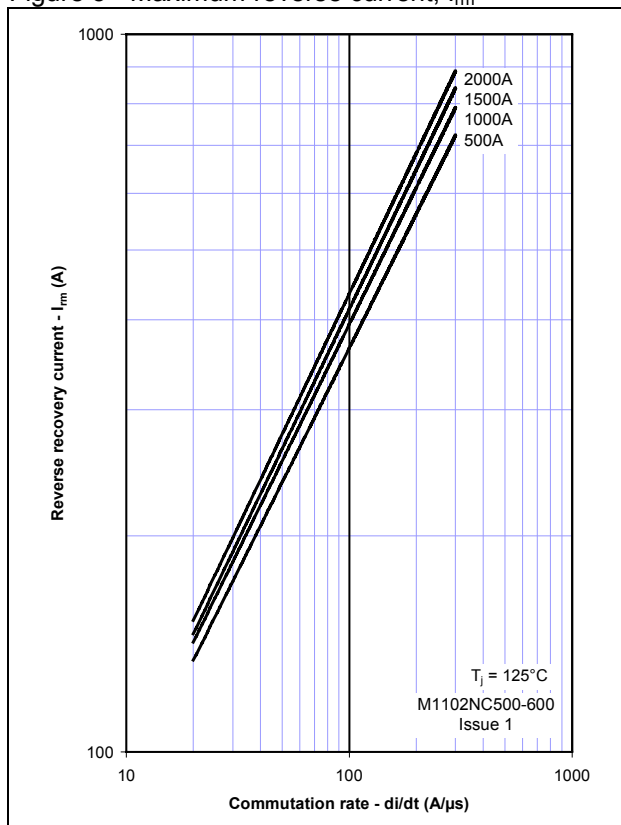


Figure 6 - Maximum recovery time,  $t_{rr}$  (50% chord)

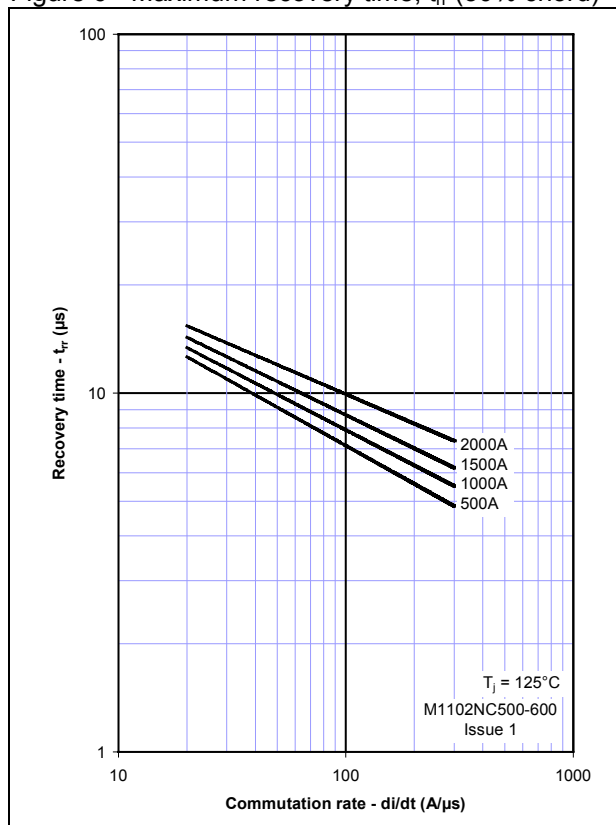


Figure 7 - Reverse recovery energy per pulse

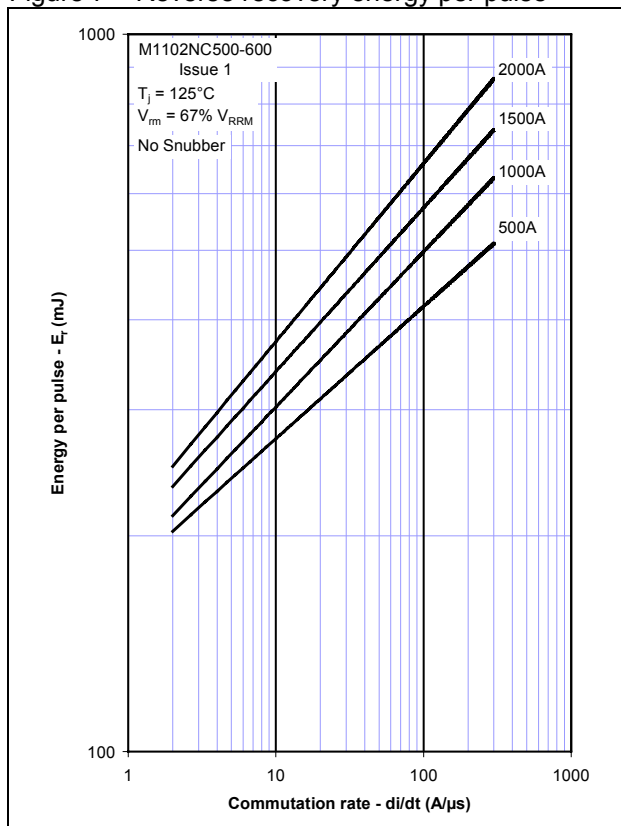


Figure 8 - Sine wave energy per pulse

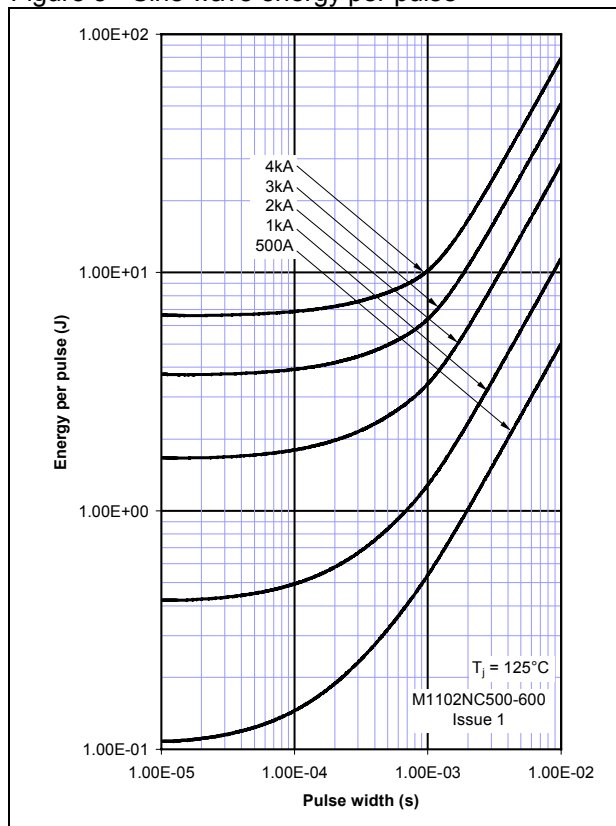


Figure 9 - Sine wave frequency vs. pulse width

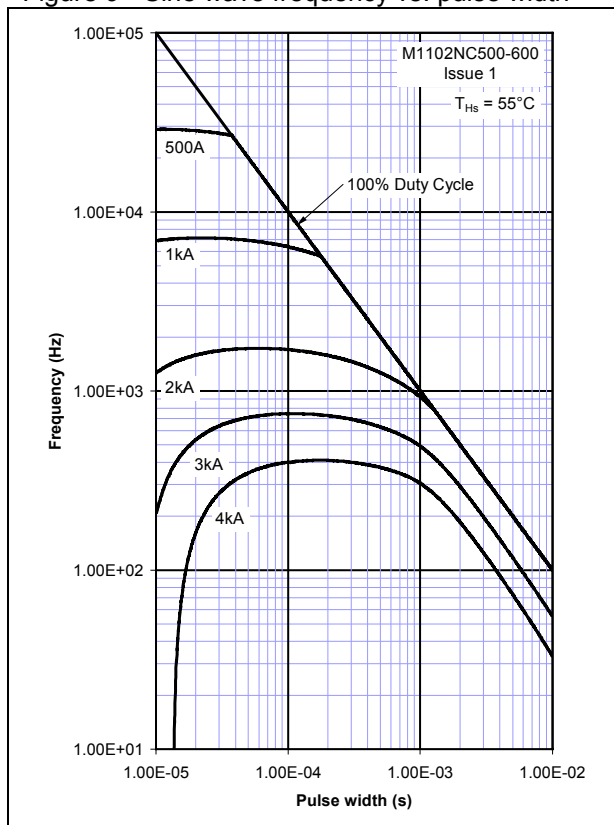


Figure 10 - Sine wave frequency vs. pulse width

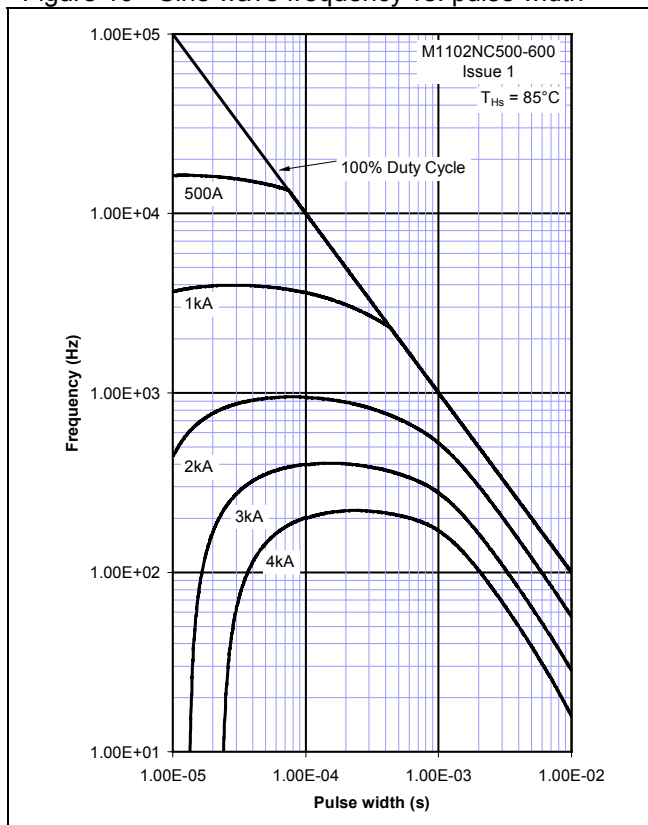


Figure 11 - Square wave energy per pulse

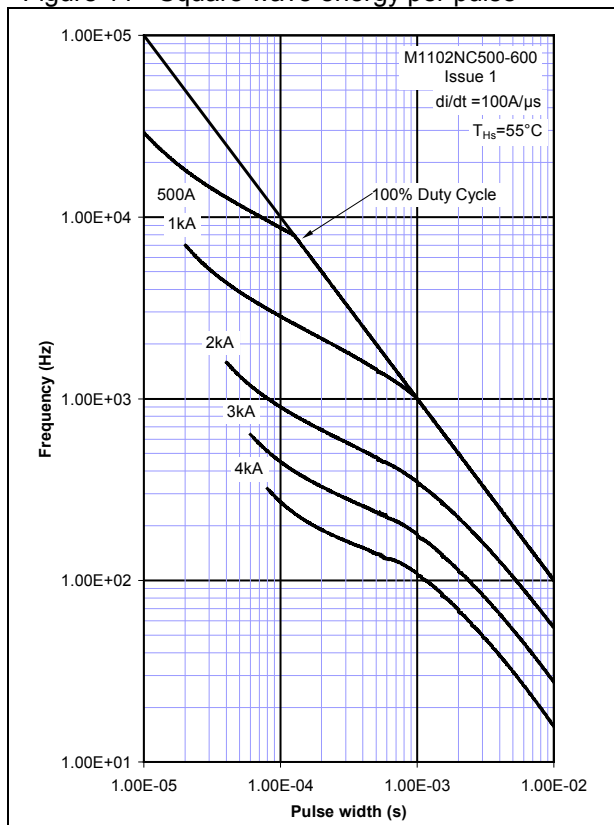


Figure 12 - Square wave energy per pulse

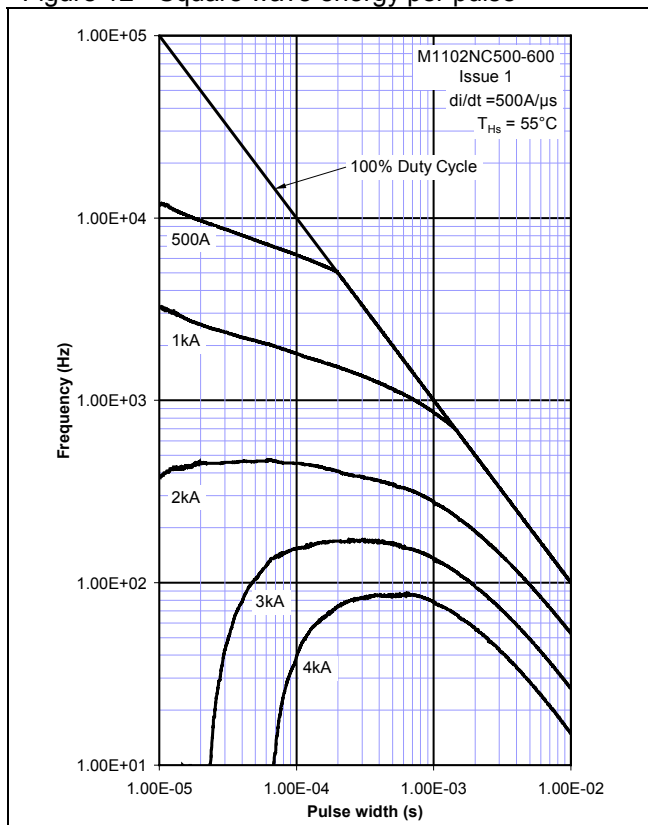




Figure 13 - Square wave frequency vs. pulse width

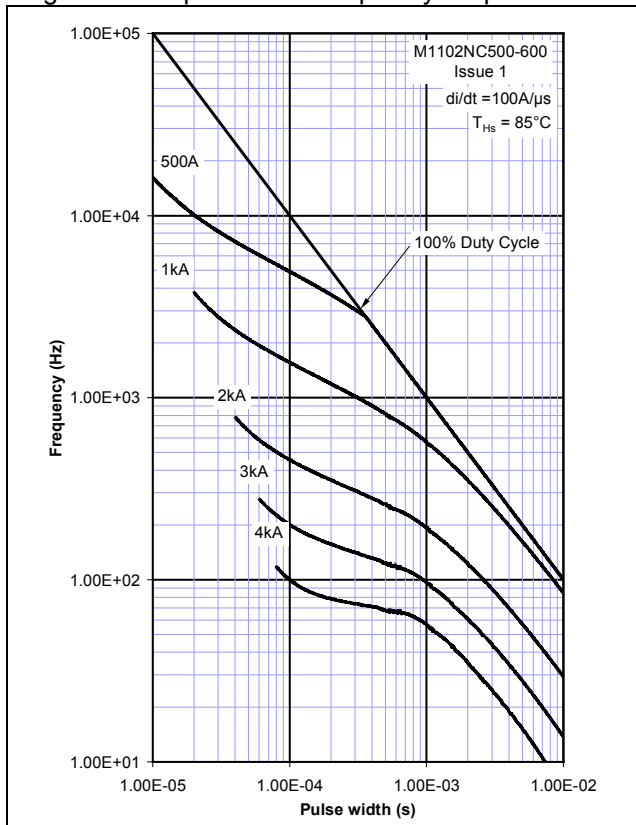


Figure 14 - Square wave frequency vs. pulse width

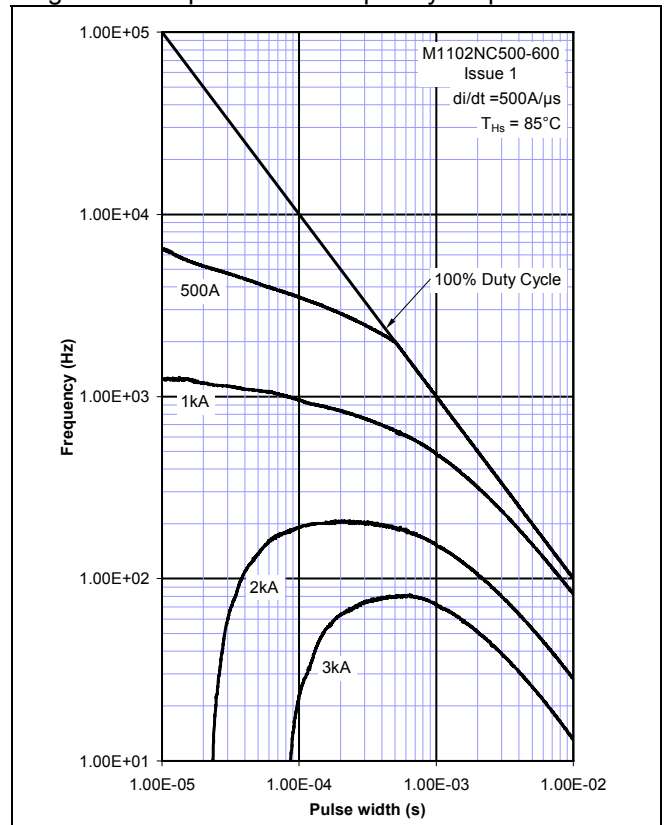


Figure 15 - Square wave frequency vs. pulse width

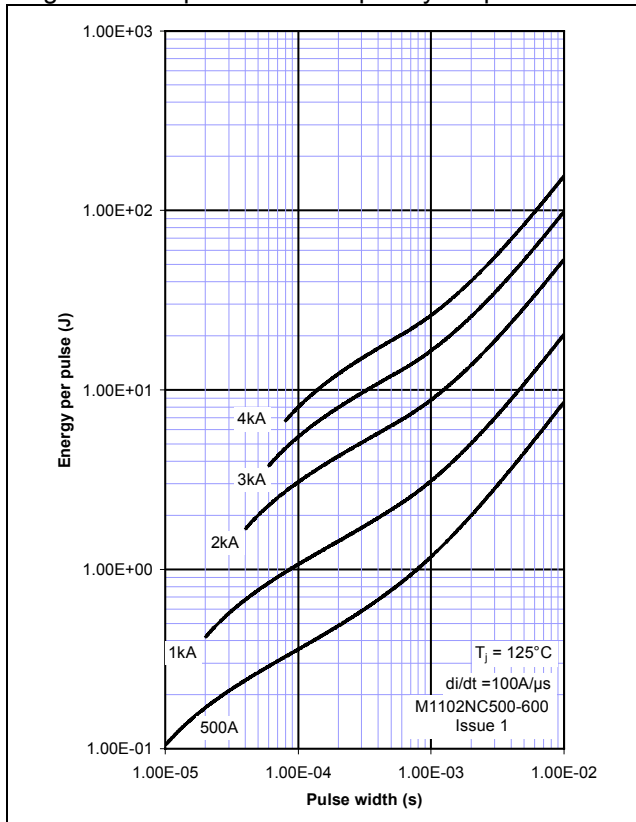


Figure 16 - Square wave frequency vs. pulse width

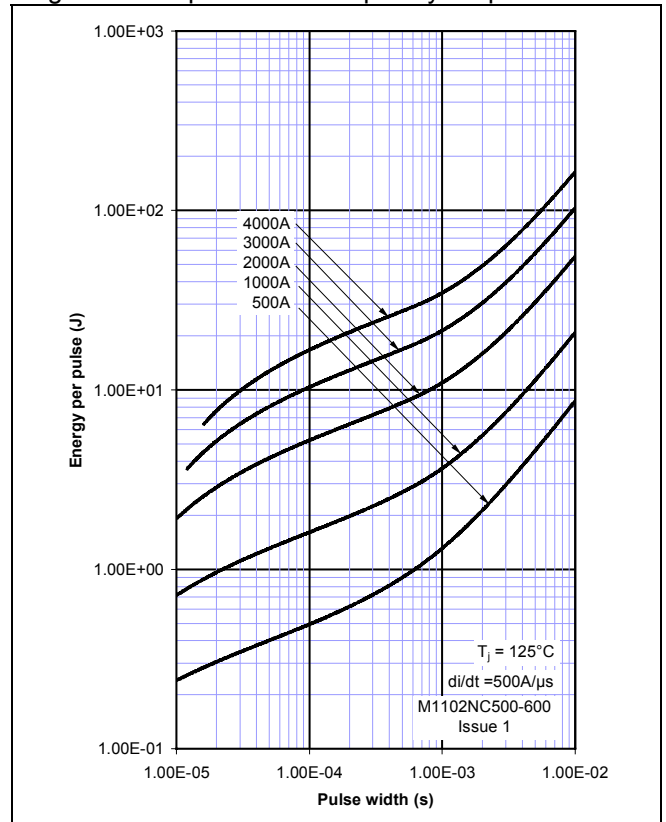


Figure 17 – Maximum surge and  $I^2t$  ratings

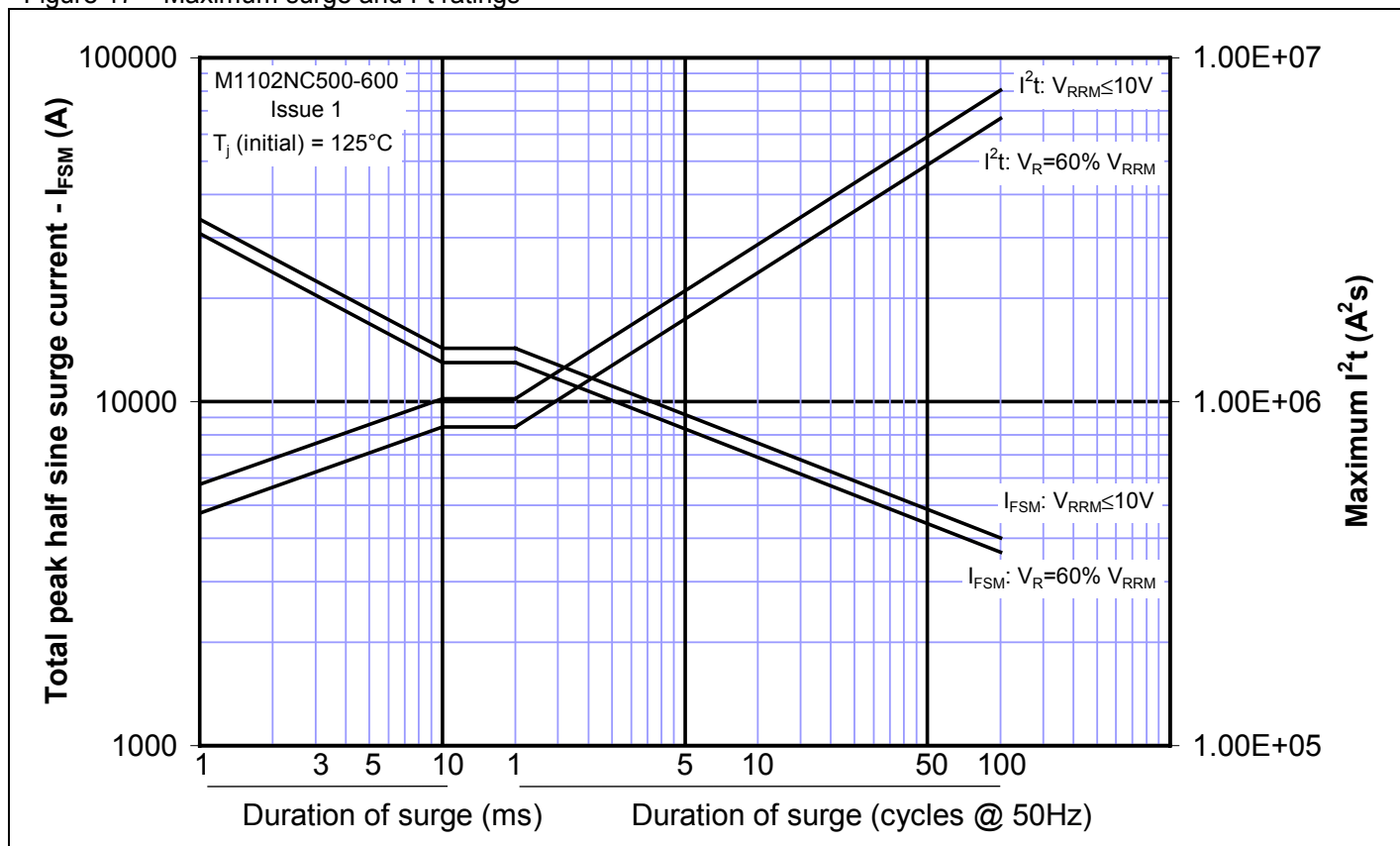
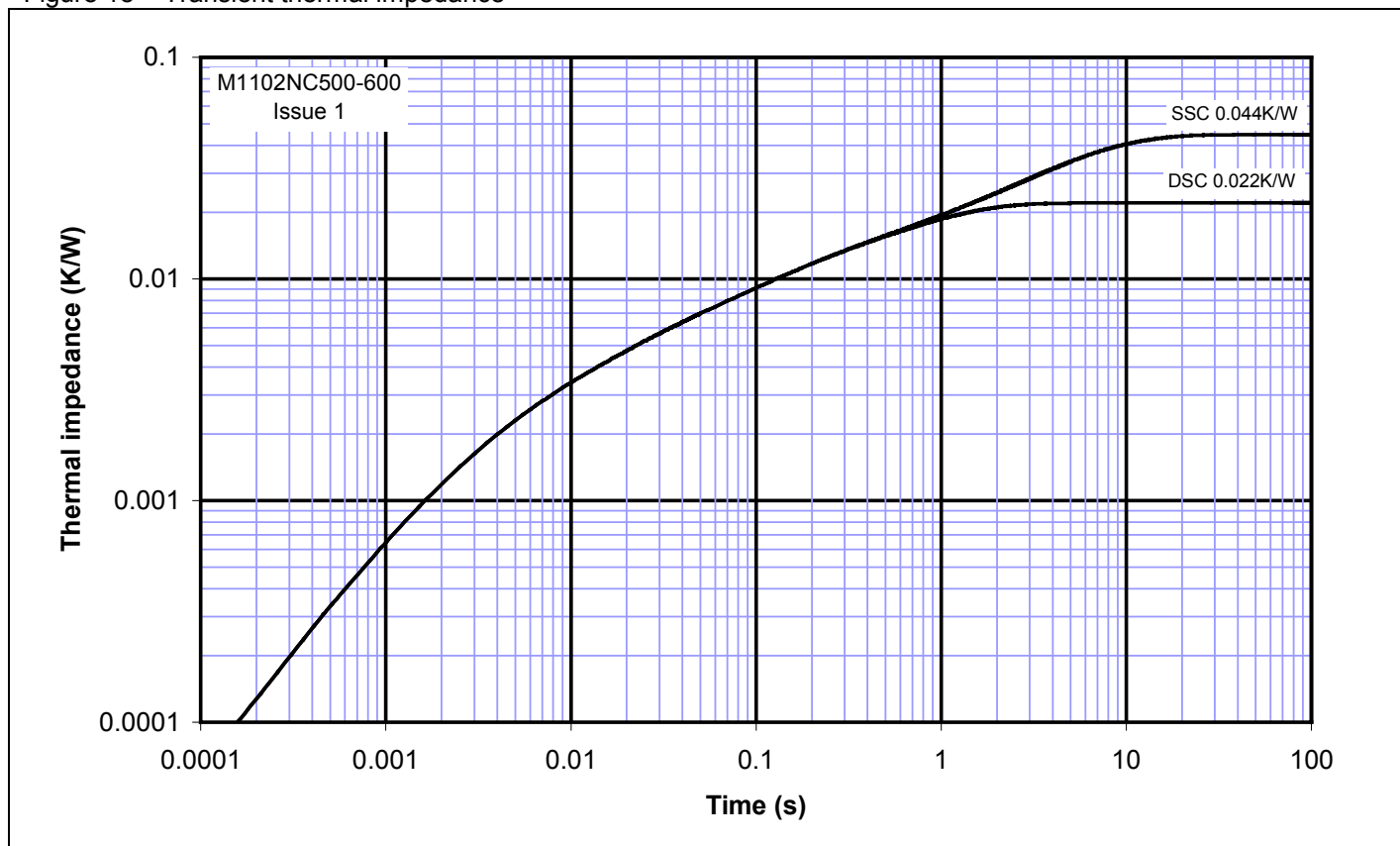
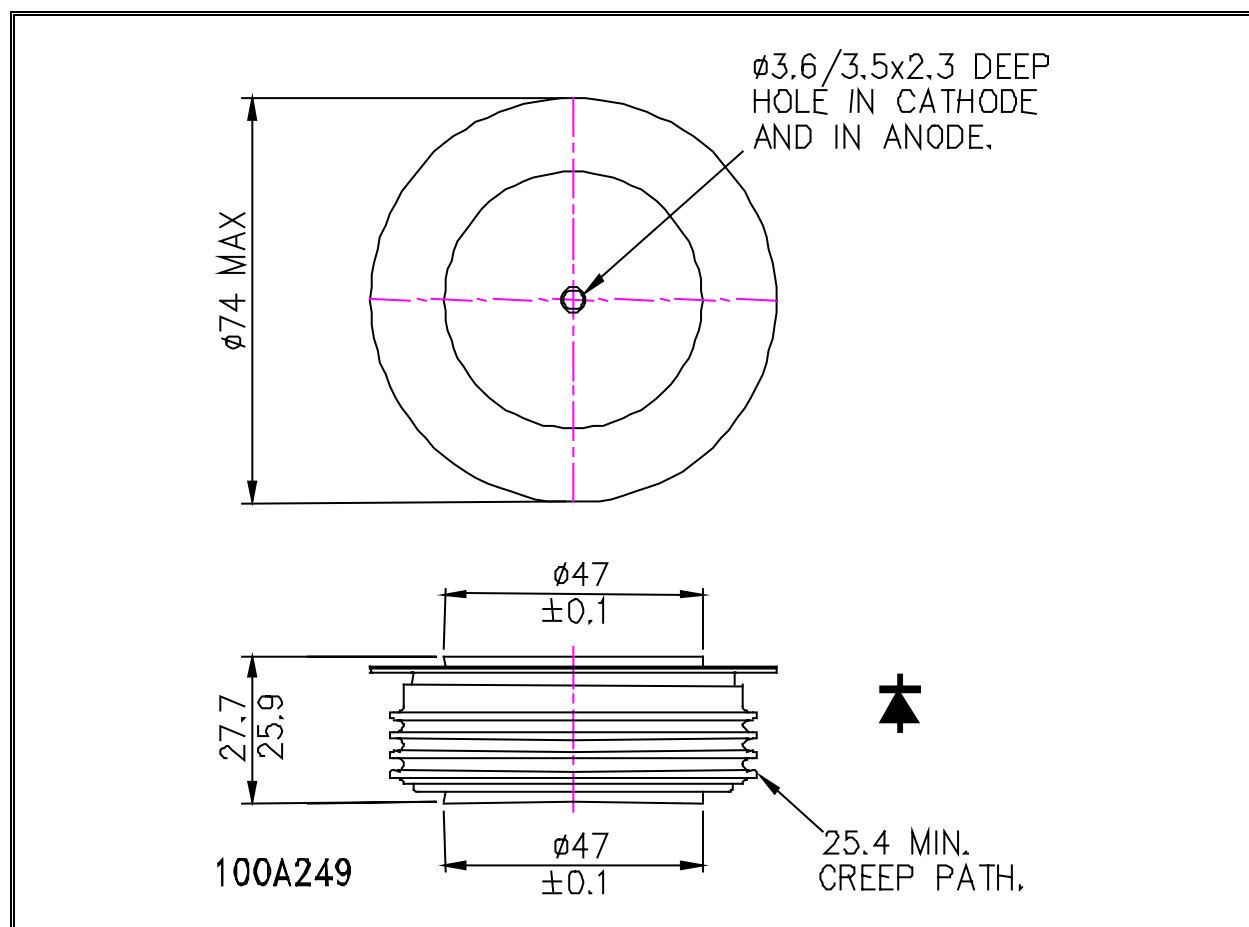


Figure 18 – Transient thermal impedance



# Outline Drawing & Ordering Information



## ORDERING INFORMATION

(Please quote 10 digit code as below)

M1102	NC	◆◆	0
Fixed Type Code	Fixed outline code	Voltage code $V_{DRM}/100$ 50-60	Fixed code

Order code: M1102NC520 – 5200V  $V_{RRM}$ , 27.7mm clamp height capsule.

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